



MSLIN-98-002CCCIP_CIPB

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June 23, 2005

To: Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject: | Serial No. 10/783,195 02/20/04 |
M.S. Lin, et al.
TOP LAYERS OF METAL FOR HIGH
PERFORMANCE IC'S
| _____ |

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation
In An Application.

The following Patents and/or Publications are submitted to
comply with the duty of disclosure under CFR 1.97-1.99 and
37 CFR 1.56.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service as first class
mail in an envelope addressed to: Commissioner for Patents,
P.O. Box 1450, Alexandria, VA 22313-1450, on June 28, 2005.

Stephen B. Ackerman, Reg.# 37761

Signature/Date *SB* 6/28/05

The Commissioner is hereby authorized to charge the IDS Processing Fee of \$180, under 37 CFR 1.17(p), to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.

U.S. Patent US 2002/0158334 A1 to Vu et al., "Microelectronic Device Having Signal Distribution Functionality of an Interfacial Layer Thereof," discusses a microelectronic device including a microelectronic die having an interfacial metal layer deposited over an active surface thereof to perform a signal distribution function within the device.

U.S. Patent 6,187,680 to Costrini et al., "Method/Structure for Creating Aluminum Wirebound Pad on Copper BEOL," discloses a method for fabricating an integrated circuit (IC) structure having an Al contact in electrical communication with Cu wiring embedded in the initial semiconductor wafer.

Sincerely,



Stephen B. Ackerman,
Reg. No. 37761

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Docket Number (Optional)

MSLIN-98-002
CCIF-CIPB

Application Number

10/783,195

Applicant

M.S. Lin et al.

Filing Date

02/20/04

Group Art Unit

U. S. PATENT DOCUMENTS

OWNER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	6187680	2/13/01	Costrini et al.	438	688	10/7/98

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

-	U.S. Patent App. Pub. U.S. 2002/0158334 A1 to Vu et al., Pub. Date 10/31/02, Filed 4/30/01, U.S. Cl. 257/723.

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.